

Description

The 74LVC1G00 is a single 2-input positive NAND gate with a standard push-pull output. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output preventing damaging current backflow when the device is powered down.

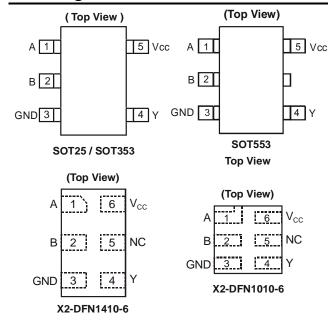
The gate performs the positive Boolean function:

$$Y = \overline{A \bullet B}$$
 or $Y = \overline{A} + \overline{B}$

Features

- Wide Supply Voltage Range from 1.65 to 5.5V
- ± 24mA Output Drive at 3.3V
- CMOS low power consumption
- I_{OFF} Supports Partial-Power-Down Mode Operation
- Inputs accept up to 5.5V
- ESD Protection Tested per JESD 22
 - Exceeds 200-V Machine Model (A115-A)
 - Exceeds 2000-V Human Body Model (A114-A)
 - Exceeds 1000-V Charged Device Model (C101C)
- Latch-Up Exceeds 100mA per JESD 78, Class II
- · Range of Package Options
- Direct Interface with TTL Levels
- All packages Assembled with "Green" Molding Compound (no Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

Pin Assignments



Applications

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- Wide array of products such as.
 - o PCs, networking, notebooks, netbooks, PDAs
 - o Tablet Computers, E-readers
 - o Computer peripherals, hard drives, CD/DVD ROM
 - o TV, DVD, DVR, set top box
 - o Cell Phones, Personal Navigation / GPS
 - o MP3 players ,Cameras, Video Recorders

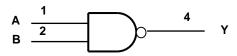
Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free. Please visit our website at http://www.diodes.com/products/lead_free.html



Pin Descriptions

Pin Name	Description
Α	Data Input
В	Data Input
GND	Ground
Y	Data Output
V_{CC}	Supply Voltage
NC	No Connection

Logic Diagram



Function Table

Inp	Output	
Α	В	Υ
Н	Н	L
L	Х	Н
X	L	Н

Absolute Maximum Ratings (Note 2)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V _{CC}	Supply Voltage Range	-0.5 to 6.5	٧
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or I _{OFF} state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.3 to V _{CC} +0.5	V
I _{IK}	Input Clamp Current V _I <0	-50	mA
I _{OK}	Output Clamp Current	-50	mA
I _O	Continuous output current	±50	mA
I _{CC} , I _{GND}	Continuous current through V _{CC} or GND	±100	mA
TJ	Operating Junction Temperature	-40 to 150	°C
T _{STG}	Storage Temperature	-65 to 150	°C

Notes: 2. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.



Recommended Operating Conditions (Note 3)

Symbol		Parameter	Min	Max	Unit
\/	Operating Voltage	Operating	1.65	5.5	V
V _{CC}	Operating Voltage	Data retention only	1.5		V
		$V_{CC} = 1.65V \text{ to } 1.95V$	0.65 X V _{CC}		
\ /	Lligh lovel logget Voltoge	$V_{CC} = 2.3V \text{ to } 2.7V$	1.7		V
V_{IH}	High-level Input Voltage	V _{CC} = 3V to 3.6V	2		V
		V _{CC} = 4.5V to 5.5V	0.7 X V _{CC}		
		V _{CC} = 1.65V to 1.95V		0.35 X V _{CC}	
\ /	Law laval ianut valtara	V _{CC} = 2.3V to 2.7V		0.7	\ /
V_{IL}	Low-level input voltage	V _{CC} = 3V to 3.6V		0.8	V
		V _{CC} = 4.5V to 5.5V		0.3 X V _{CC}	
VI		Input Voltage	0	5.5	V
Vo	C	Output Voltage	0	V _{CC}	V
	High-level output current	V _{CC} = 1.65V		-4	
		V _{CC} = 2.3V		-8	
I_{OH}		V 2V		-16	mA
		$V_{CC} = 3V$		-24	
		V _{CC} = 4.5V		-32	
		V _{CC} = 1.65V		4	
		V _{CC} = 2.3V		8	
I_{OL}	Low-level output current	V _{CC} = 3V		16	mA
		v _{CC} = 3v		24	
		V _{CC} = 4.5V		32	
	1 (1 12 1 1 1 1 1	$V_{CC} = 1.8V \pm 0.15V, 2.5V \pm 0.2V$		20	
$\Delta t/\Delta V$	Input transition rise or fall	$V_{CC} = 3.3V \pm 0.3V$		10	ns/V
	rate	$V_{CC} = 5V \pm 0.5V$		5	
T _A	Operating free-air temperature		-40	125	°C

Notes: 3. Unused inputs should be held at $V_{\mbox{CC}}$ or Ground.



Electrical Characteristics (All typical values are at $V_{CC} = 3.3V$, $T_A = 25$ °C)

0	D	Tank Camalidiana	W	-40	-40°C to 85°C		-40°C to 125°C		11
Symbol	Parameter	Test Conditions	V _{CC}	Min	Тур.	Max	Min	Max	Unit
		I _{OH} = -100μA	1.65V to 5.5V	V _{CC} – 0.1			V _{CC} – 0.1		
		I _{OH} = -4mA	1.65V	1.2			0.95		
V _{OH}	High Level Output	$I_{OH} = -8mA$	2.3V	1.9			1.7		V
VOH	Voltage	I _{OH} = -16mA	3V	2.4			2.2		v
	l	I _{OH} = -24mA	3 V	2.3			2.0		
		I _{OH} = -32mA	4.5V	3.8			3.4		
		$I_{OL} = 100 \mu A$	1.65V to 5.5V			0.1		0.1	
	l	I _{OL} = 4mA	1.65V			0.45		0.7	
V _{OL}	Low Level I _{OL} = 8mA 2.3V	2.3V			0.3		0.45	V	
VOL	Output Voltage	I _{OL} = 16mA	3V			0.4		0.6	
	l	$I_{OL} = 24mA$	3 V			0.55		0.8	
		$I_{OL} = 32mA$	4.5V			0.55		.8	
II	Input Current	$V_I = 5.5V$ or GND	0 to 5.5V		± 0.1	±5		± 100	μΑ
l _{OFF}	Power Down Leakage Current	V_I or $V_O = 5.5V$	0V			±10		±200	μA
Icc	Supply Current	$V_I = 5.5V$ or GND $I_O=0$	5.5V		0.1	10		200	μΑ
ΔI _{CC}	Additional Supply Current	One input at V _{CC} – 0.6V Other inputs at V _{CC} or GND	3V to 5.5V			500		5000	μA
Ci	Input Capacitance	$V_i = V_{CC} - \text{or GND}$	3.3V		5				pF

Package Characteristics (All typical values are at V_{CC} = 3.3V, T_A = 25°C)

Symbol	Parameter	Test Conditions	V _{CC}	Min	Тур.	Max	Unit
		SOT25			204		
	Thermal Resistance Junction-to-Ambient	SOT353			371		°C/W
θ_{JA}		SOT553	(Note 4)		231		C/VV
		X2-DFN1010-6			445		
		X2-DFN1410-6			460		
		SOT25	(Note 4)		52		
	The was all Desistance	SOT353			143		°C/W
θ_{JC}	Thermal Resistance Junction-to-Case	SOT553			105		
		X2-DFN1010-6			250		
		X2-DFN1410-6			265		

Notes: 4. Test condition for SOT25, SOT353, SOT553, X2-DFN1410-6 and X2-DFN1010-6: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



Switching Characteristics

Figure 1 Typical Values at T_A = 25 °C and nominal voltages 1.8V, 2.5V, 2.7V, 3.3V, and 5.0V.

Parameter	From	То	V	T _A	= -40°C to 8	5ºC	$T_A = -40^{\circ}$	C to 125ºC	Unit			
Parameter	Input	Output	V _{CC}	Min	Тур	Max	Min	Max	Unit			
			1.8V ± 0.15V	1.0	3.3	8.0	1.0	10.5				
			2.5V ± 0.2V	0.5	2.2	5.5	0.5	7.0				
t _{pd}	A or B	A or B	A or B	A or B	Υ	2.7V	0.5	2.6	5.8	0.5	7.5	ns
	·			$3.3V \pm 0.3V$	0.5	2.2	4.7	0.5	6.0			
			5.0V ± 0.5V	0.5	1.8	4.0	0.5	5.5				

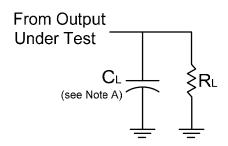
Operating Characteristics

 $T_A = 25$ °C

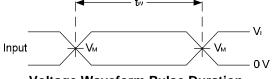
	Parameter		V _{CC} = 1.8V Typ.	V _{CC} = 2.5V Typ.	V _{CC} = 3.3V Typ.	V _{CC} = 5V Typ.	Unit
C _{pd}	Power dissipation capacitance	f = 10 MHz	22	22	23	25	pF



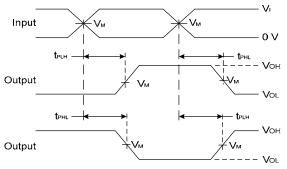
Parameter Measurement Information



V _{CC}	In	puts	. V _M	CL	RL	
VCC	VI	t _r /t _f	V M	O _L	KL	
1.8V ± 0.15V	V _{CC}	≤2ns	V _{CC} /2	30 pF	1 ΚΩ	
2.5V ± 0.2V	V _{CC}	≤2ns	V _{CC} /2	30 pF	500 Ω	
2.7V	V _{CC}	≤2.5ns	1.5V	50 pF	500 Ω	
3.3V ± 0.3V	3.0V	≤2.5ns	1.5V	50 pF	500 Ω	
5.0V ± 0.5V	V _{CC}	≤2.5ns	V _{CC} /2	50 pF	500 Ω	



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Figure 1. Load Circuit and Voltage Waveforms

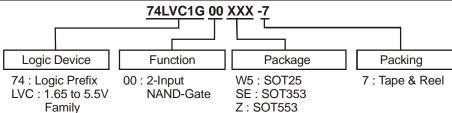
A. Includes test lead and test apparatus capacitance.B. All pulses are supplied at pulse repetition rate ≤ 10 MHz.

C. Inputs are measured separately one transition per measurement.

D. t_{PLH} and t_{PHL} are the same as t_{PD}.



Ordering Information



1G : One Gate FW4 : X2-DFN1010-6 FZ4 : X2-DFN1410-6

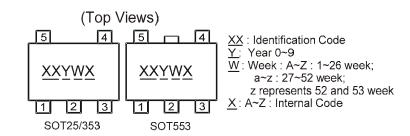
	Dovice	Device Package		7" Tape and Reel		
	Code		(Note 6)	Quantity	Part Number Suffix	
b	74LVC1G00W5-7	W5	SOT25	3000/Tape & Reel	-7	
b	74LVC1G00SE-7	SE	SOT353	3000/Tape & Reel	-7	
b	74LVC1G00Z-7	Z	SOT553	4000/Tape & Reel	-7	
b	74LVC1G00FW4-7	FW4	X2-DFN1010-6	5000/Tape & Reel	-7	
9	74LVC1G00FZ4-7	FZ4	X2-DFN1410-6	5000/Tape & Reel	-7	

Notes:

- Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 6. The taping orientation is located on our website at http://www.diodes.com/datasheets/ap02007.pdf

Marking Information

(1) SOT25, SOT353 and SOT553



Part Number	Package	Identification Code
74LVC1G00W5	SOT25	US
74LVC1G00SE	SOT353	US
74LVC1G00Z	SOT553	US

(2) X2-DFN1010-6 and X2-DFN1410-6

(Top View)

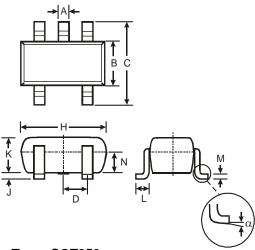
XX : Identification Code
Y: Year 0-9
W: Week: A-Z: 1-26 week;
a∼z: 27-52 week;
z represents 52 and 53 week
X: A-Z: Internal Code

Part Number	Package	Identification Code
74LVC1G00FW4	X2-DFN1010-6	US
74LVC1G00FZ4	X2-DFN1410-6	US



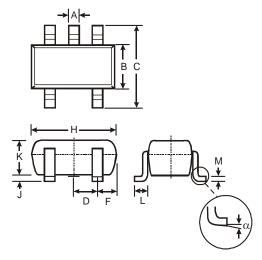
Package Outline Dimensions (All Dimensions in mm)

(1) Package Type: SOT25



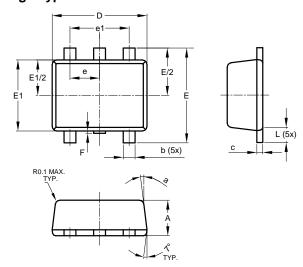
SOT25			
Dim	Min	Max	Тур
Α	0.35	0.50	0.38
В	1.50	1.70	1.60
С	2.70	3.00	2.80
D	_	_	0.95
Н	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
М	0.10	0.20	0.15
N	0.70	0.80	0.75
α	0°	8°	_
All Dimensions in mm			

(2) Package Type: SOT353



SOT353			
Dim	Min	Max	
Α	0.10	0.30	
В	1.15	1.35	
O	2.00	2.20	
D	0.65 Typ		
F	0.40	0.45	
H	1.80	2.20	
7	0	0.10	
K	0.90	1.00	
٦	0.25	0.40	
М	0.10	0.22	
α	0°	8°	
All Dimensions in mm			

(3) Package Type: SOT553

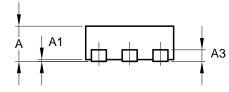


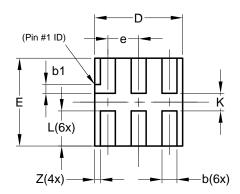
SOT553			
Dim	Min	Max	Тур
Α	0.55	0.62	0.60
b	0.15	0.30	0.20
C	0.10	0.18	0.15
D	1.50	1.70	1.60
Е	1.55	1.70	1.60
E1	1.10	1.25	1.20
е	0.50 BSC		
e1	1.00 BSC		
F	0.00	0.10	_
L	0.10	0.30	0.20
а	6°	8°	7°
All Dimensions in mm			



Package Outline Dimensions (cont.)

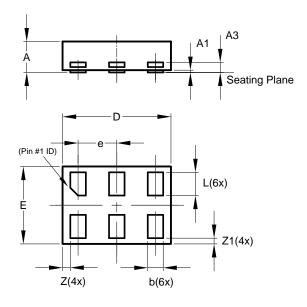
(4) Package Type X2-DFN1010-6





	X2-DFN1010-6			
Dim	Min	Max	Тур	
Α	_	0.40	0.39	
A1	0.00	0.05	0.02	
А3			0.13	
b	0.14	0.20	0.17	
b1	0.05	0.15	0.10	
D	0.95	1.05	1.00	
Е	0.95	1.05	1.00	
е			0.35	
L	0.35	0.45	0.40	
K	0.15	_	_	
Z			0.065	
All Dimensions in mm				

(5) Package Type: X2-DFN1410-6

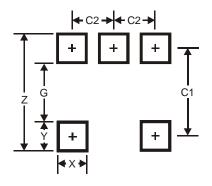


X2-DFN1410-6			
Dim	Min	Max	Тур
Α		0.40	0.39
A1	0.00	0.05	0.02
А3	_	_	0.13
b	0.15	0.25	0.20
ם	1.35	1.45	1.40
Е	0.95	1.05	1.00
е	_	_	0.50
٦	0.25	0.35	0.30
Z	_	_	0.10
Z 1	0.045	0.105	0.075
All Dimensions in mm			



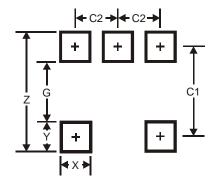
Suggested Pad Layout

(1) Package Type: SOT25



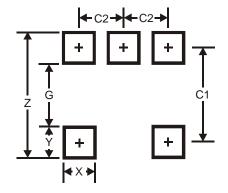
Dimensions	Value (in mm)
Z	3.20
G	1.60
х	0.55
Y	0.80
C1	2.40
C2	0.95

(2) Package Type: SOT353



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Y	0.6
C1	1.9
C2	0.65

(3) Package Type: SOT553

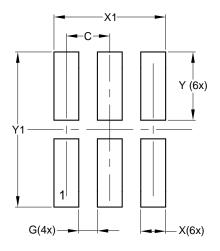


Dimensions	Value (in mm)	
Z	2.2	
G	1.2	
Х	0.375	
Y	0.5	
C1	1.7	
C2	0.5	



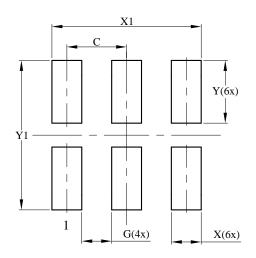
Suggested Pad Layout (cont.)

(4) Package Type X2-DFN1010-6



Dimensions	Value (in mm)
С	0.350
G	0.150
Х	0.200
X1	0.900
Y	0.550
Y1	1.250

(5) Package Type: X2-DFN1410-6



Dimensions	Value (in mm)
С	0.500
G	0.250
Х	0.250
X1	1.250
Y	0.525
V1	1 250



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